








2 layer; Aluminium-Core PCB 35µm

Layer	Description	Stack-up	Thickness	Type
	Solder mask		20,0 µm	laquer
Top Layer 1	Copper		35,0 µm	Cu
	Prepreg		150,0 µm	Epoxy
	Base core		1200,0 µm	Aluminium
	Prepreg		150,0 µm	Epoxy
Bottom Layer 2	Copper		35,0 µm	Cu
	Solder mask		20,0 µm	laquer
total thickness:			1,610 mm	
tolerance:			10%	
maximum thickness:			1,771 mm	
minimum thickness:			1,449 mm	